PARAMETER	
Junction-to-Ambient	

Notes a. Package limited.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

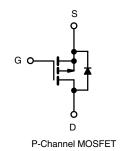
c. When mounted on 1" square PCB (FR-4 material).

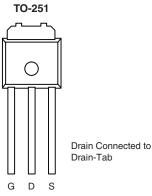
PRODUCT SUMMARY				
V _{DS} (V)	- 60			
$R_{DS(on)}(\Omega)$ at V_{GS} = - 10 V	0.0135			
$R_{DS(on)}(\Omega)$ at V_{GS} = - 4.5 V	0.017			
I _D (A)	- 50			
Configuration	Single			



- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g and UIS Tested







Top View

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	- 60	V
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current ^a	T _C = 25 °C	- I _D	- 50	А
	T _C = 125 °C		- 38	
Continuous Source Current (Diode Conduct	ion) ^a	I _S	- 50	
Pulsed Drain Current ^b	I _{DM}	- 200		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 52	
Single Pulse Avalanche Energy		E _{AS}	135	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	P	136	w
	T _C = 125 °C	P _D	45	vv
Operating Junction and Storage Temperature Range		TJ, T _{stg}	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount ^c	R _{thJA}	50	°C/W		
Junction-to-Case (Drain)		R _{thJC}	1.1	0/10		

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		-						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$		- 60	-	-	v	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA		- 1.5	-	- 2.5	v	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = - 60 V	-	-	- 1		
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	V_{DS} = - 60 V, T _J = 125 °C	-	-	- 50	μA	
		$V_{GS} = 0 V$	V_{DS} = - 60 V, T _J = 175 °C	-	-	- 150		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	$V_{DS} \ge$ - 5 V	- 50	-	-	Α	
		V _{GS} = - 10 V	I _D = - 17 A	-	0.0135	-	- Ω	
Drain Courses On State Desistence	Р	V _{GS} = - 10 V	$I_D = -50 \text{ A}, \text{ T}_J = 125 ^\circ\text{C}$	-	0.026	-		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 50 A, T _J = 175 °C	-	0.032	-		
		$V_{GS} = -4.5 V$	I _D = - 14 A	-	0.017	-		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 17 A		-	50	-	S	
Dynamic ^b	• •							
Input Capacitance	C _{iss}			-	4730	5910	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$ $V_{DS} = -25 V$, f = 1 MHz	V _{DS} = - 25 V, f = 1 MHz	-	485	606		
Reverse Transfer Capacitance	C _{rss}			-	330	410		
Total Gate Charge ^c	Qg			-	98	150		
Gate-Source Charge ^c	Q _{gs}	$V_{GS} = - 10 V$	V_{DS} = - 30 V, I_{D} = - 50 A	-	15	23	nC	
Gate-Drain Charge ^c	Q _{gd}			-	21	32]	
Gate Resistance	Rg	f = 1 MHz		1.47	2.9	4.42	Ω	
Turn-On Delay Time ^c	t _{d(on)}			-	15	18		
Rise Time ^c	t _r	V_{DD} = - 30 V, R _L = 0.6 Ω I _D \cong - 50 A, V _{GEN} = - 10 V, R _g = 6.0 Ω		-	12	16	- ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	112	125		
Fall Time ^c	t _f			-	39	48		
Source-Drain Diode Ratings and Chara	acteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	- 200	Α	
Forward Voltage	V _{SD}	I _F = -	_	- 0.8	- 1.5	V		

Notes

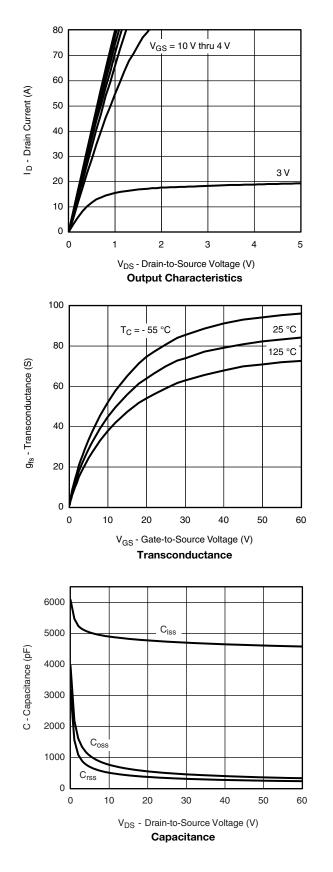
a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%.$

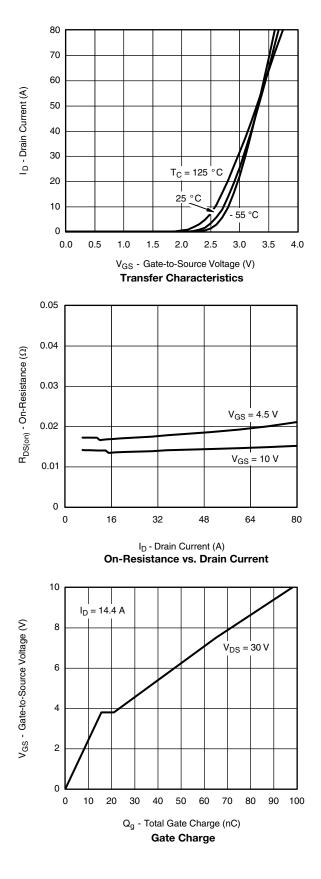
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

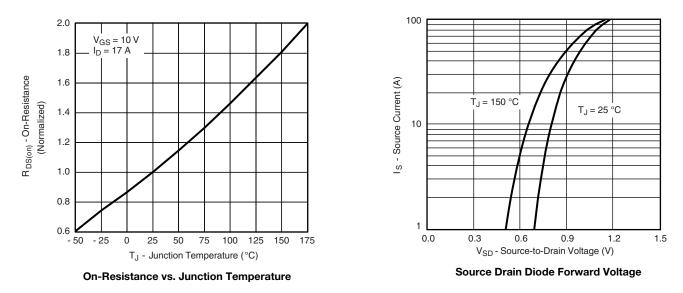


TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

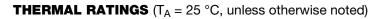


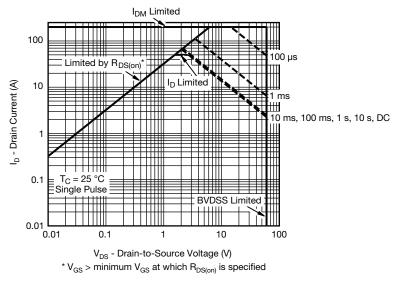






TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

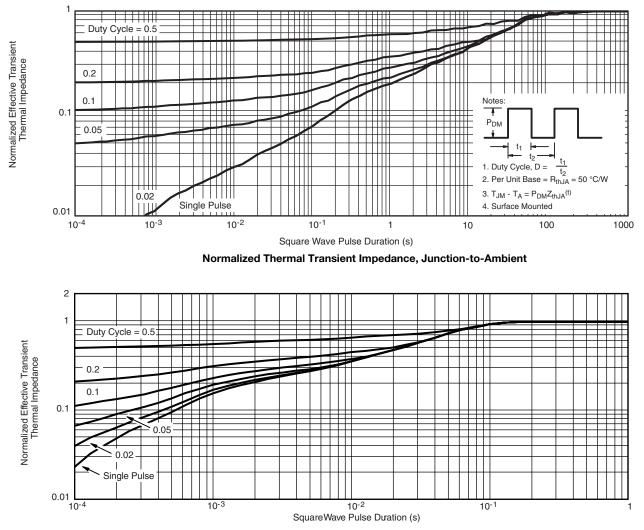








THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

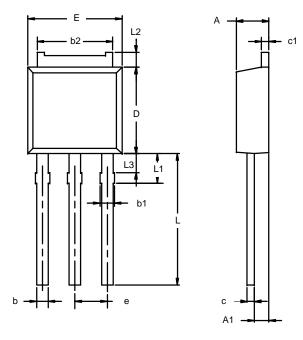
- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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TO-251AA



	MILLIN	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28	BSC	0.090 BSC		
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

Note: Dimension L3 is for reference only.



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